

swiss scientific initiative in health / security / environment systems

MIXSEL2

• High peak power:





RBW: 300 kHz

20

FHWM:

5.4 nm

Sub-200 fs-MIXSEL

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Motivation

Potential applications of ultrafast **semiconductor disk lasers** (SDL)





biomedical imaging



0.6

 $\tau_{\rm p} = 279 \, {\rm fs}$



natural user interface

metrology

- first CEO-frequency detection of a SESAMmodelocked VECSEL^[1]
- amplified and recompressed 238-fs pulses from a 100-mW VECSEL

Enabling key technology for applications at 1-100 GHz repetition rate

[1] C.A. Zaugg et. al., Optics Express (2014) Vol. 22, 16445-16455





MIXSEL concept

- Semiconductor based
- Integrated saturable absorber
- Potential for monolithic design
- Low noise operation
- Straight cavity for simplified repetition rate scalability



Mirror



20.6

Carriers pumped into the gain QWs create a reservoir. A fspulse is not using all the carriers for stimulated emission.

modelocking results		
28.1 ps	6.4 W	2.5 GHz
pulse duration	output power	repetition rate
230 fs	132 mW	3.9 GHz



- Cavity Surface Emitting Laser
- Highest output power of a modelocked semiconductor laser^[2]
- Shortest pulse duration from a MIXSEL
- Femtosecond operation at 100 GHz: highest repetition rate of any fundamental mode locked SDL^[3]

[2] B. Rudin, et al., Opt. Exp. (2010) vol. 18, pp. 27582 [3] M. Mangold et al., Optics Express, vol. 22, No. 5, pp. 6099-6107, 2014



- Easier access to strain compensation
- More uniform structure for better performances
- Industry-oriented large scale MIXSEL production



MOVPE absorber characterisation

Single quantum-well (QW) absorber

Fast recovery time (< 5 ps)

 \checkmark



'ity (%) ∆R ≈ 2% 99 Reflecti Z 0.2 • Measurement --- Fit ž 100 1000 0.1 Fluence (µJ/cm²)

.-<10µJ/cm²

100

‡∆R_{ns} ≈ 0.2%



Where the electric field is more intense (i.e. X pump DBR, AR section) TPA is increased

Low bandgap materials (i.e. GaAs, GaAsP, Al₁₅Ga₈₅As) contribute more to TPA

Design full dielectric AR section and reduce the electric field in the pump DBR

GaAsP InGaAs fused silica

Use large bandgap materials (i.e. AlAsP) for strain compensation instead of GaAsP



- We demonstrated the first generation of MOVPE MIXSELs:
- Pulse duration was shortened by a faster absorber.
- recovery time pulse duration output power



- At this point still a trade-off between faster absorber and low non-saturable losses.
- Lower *F*_{sat} will allow sub-300-fs operation from MOVPE MIXSELs

Outlook



sub-200-fs pulses with > 1 kW peak next steps: power from a MIXSEL

ultimate goal: fully stabilized frequency comb (repetition rate & CEO-frequency) from a compact, low cost MIXSEL



refracti electric